

Government of India
Ministry of Communications
Department of Telecommunications
Telecommunication Engineering Centre
Khurshid Lal Bhawan, Janpath, New Delhi 110001.

No: 19-09/2023-STD/TEC

Dated 20-03-2023

Notice for Inviting Public Comments

Subject: Inviting public comments on TSDSI transposed standards corresponding to the new and updated specifications of 3GPP Release 15, 16 and 17 (total 2579 documents), for their adoption into National Standards by TEC

Telecommunications Engineering Centre (TEC), Department of Telecommunication (DOT) has approved a policy for adoption of standards of Telecom Standards Development Society, India (TSDSI)/international standards bodies into National Standards. "Standardisation Guide" – a policy document for adoption of telecom and related ICT standards defines the process of adoption/ratification of TSDSI/international standards like institutional mechanism, process of adoption, maintenance of standards, numbering plan, stakeholder consultation etc

(Refer the Standardization Guide- <https://www.tec.gov.in/pdf/M2M/Standardisation%20guide.pdf>).

Telecom Standards Advisory Committee (TSAC) – a Standing apex committee under the chairmanship of DDG (Standardisation), TEC in its meeting held on 16-03-2023 has decided to initiate the process of adoption of TSDSI transposed standards corresponding to the new and updated specifications of 3GPP Release 15, 16 and 17 (total 2579 documents) as National Standard.

As a next step in adoption process, all the stakeholders are requested to offer their comments on the TSDSI transposed documents. The details in this regard are as given below:

S. No	Item	Description
i.	Adoption of Standards	Seeking public comments on TSDSI transposed standards corresponding to the new and updated specifications of 3GPP Release 15, 16 and 17 (total 2579 documents)
ii.	Division	Standardisation Division, TEC
iii.	Date of Release	20 th March 2023

iv.	Date of Closing	19 th April 2023
v.	Comments to be mailed to	dirsted.tec-dot@gov.in , adgs.tec-dot@gov.in
vi	Document	Documents available at Annexure-I

All the stakeholders are requested to mail their comments by 19.04.2023 at dirsted.tec-dot@gov.in , adgs.tec-dot@gov.in It may be kept into consideration while offering the comments that only technical content or the amendments affecting the technical content of standard shall be open for public comments, as per Para 6.2.4 of the Standardisation Guide.

For any query or clarification, please contact dirsted.tec-dot@gov.in



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Director (Standardization)
Telecommunication Engineer Centre (TEC)
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To,

- i) Director (IT), TEC to upload the notice on TEC website for public comments
- ii) Director (IT), to upload the notice on DoT website for public comments
- iii) DG, TSDSI to upload the notice on TSDSI website for public comments

Annexure-I

The specifications are available at the links mentioned in the table below:

Releases	Links for transposed Specifications
Release 15	https://members.tdsi.in/s/YKRTfsX7sZnSBBL
Release 16	https://members.tdsi.in/s/3oQKqK2KnstgJA5
Release 17 Cycle 2	https://members.tdsi.in/s/ZM8SFwPqFDoyHaz